

AMENDMENTS TO THE CLAIMS:

The listing of claims will replace all prior versions, and listing, of claims in the application:

LISTING OF CLAIMS

Claims 1-8 (canceled).

- 1 9. (Currently Amended) A photoresist laminate comprising:
2 a substrate;
3 a photoresist pattern with a reinforcing section formed by using an exposure and a
4 developing solution,
5 a sublayer film provided between the substrate and the photoresist pattern, the sublayer
6 film being soluble in a developing solution used to form the photoresist pattern; and
7 wherein there is provided in said photoresist pattern, a line section and [[a]] reinforcing
8 section that continues to said line section, and [[that]] said reinforcing section has a greater width
9 than a line width of said line section.

Claims 10-13 (canceled).